IPC ASSOCIATION CONNECTION ELECTRONICS INDUSTRI	© Copyright 2005. IPC.	terial Composition Declaration pyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both national and Pan-American copyright conventions.			Th lev	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Form Type Distribute					Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and					and Mfg Information			
upplier Inforn	nation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi												2024-05-02			
ontact Name		Title - Contact			I	Phone - Contact*				Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized Repres	entative*	Title - Representative			I	Phone - Representative*			Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Request	quester Item Number Mfr Item		n Number Mfr Item Name				Effective Da	ite Vers	sion	Manufacturing Site		Weight*	UOM	Unit Type	
		pre-dri		1PH PRE SENSOR CLOSE; Single phase pre-driver with hall sensor method (closed loop speed control)			2024-05-02		PHM			80.0	mg	Each	
Ianufacturing	Proccess Informatio	n													
Terminal Plating / Grid Array Material T		Γerminal Base Alloy J-ST		-STD-020 MSL R	ating	Peak Process Body Temper		dy Temperat	ure Max Time at Peak Tempe		ture Numbe	er of Reflow Cyc	eles		
contains Bi		CU Alloy 3				260	260 C 30		seconds 3						
omments															
TTENTION: MS	L 3 Rated item requires B	ake and D	ry Pack (after	electrical test)											
or more informat	ion regarding material cor	nposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimuly and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.9	mg	Supplier	Silicon (Si)	7440-21-3		3.8856	mg
			Supplier	Polyimide	Proprietary Data		0.0144	mg
Die Attach	0.38	mg	Supplier	Silver (Ag)	7440-22-4		0.2907	mg
			Supplier	Epoxy resins	129915-35-1		0.0893	mg
Lead Frame	25.4	mg	Supplier	Silver (Ag)	7440-22-4		0.6325	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0483	mg
			Supplier	Iron (Fe)	7439-89-6		0.6426	mg
			Supplier	Copper (Cu)	7440-50-8		24.0411	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0356	mg
Mold Compound-Black	48.74	mg		Epoxy Phenol Resin	proprietary data		5.8488	mg
			Supplier	Carbon Black (C)	1333-86-4		0.195	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		41.234	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		1.4622	mg
Plating	1.42	mg	В	Bismuth (Bi)	7440-69-9		0.0085	mg
			Supplier	Tin (Sn)	7440-31-5		1.4115	mg
Wire Bond - Au	0.16	mg	Supplier	Gold (Au)	7440-57-5		0.16	mg